

Title (en)

MULTI-LAYERED SYSTEMS CONTAINING ANTI-STATIC MOULDING MATERIALS

Title (de)

MEHRSCHEIDIGESYSTEME ENTHALTEND ANTISTATISCHE FORMMASSEN

Title (fr)

SYSTEMES MULTICOUCHES COMPORTANT DES MATERIES MOULEES ANTISTATIQUES

Publication

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Application

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Abstract (en)

[origin: WO02085613A2] The invention relates to layered systems made of thermoplastic moulding materials and products produced according to said layered systems, particularly boards, which have a reduced tendency for attracting dust and which do not become electrostatically charged during the production and the use thereof.

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IPC 8 full level

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